



ULTRA-SMALL CERAMIC

Power Splitter/Combiner

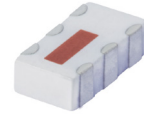
QCN-12AD+

Mini-Circuits

2 Way-90° 50Ω 800 to 1250 MHz

FEATURES

- Low insertion loss, 0.4 dB typ.
- Wrap-around terminal for excellent solderability
- Ultra small, 0.12"X0.06"X0.035"



Generic photo used for illustration purposes only

CASE STYLE: FV1206-1

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

APPLICATIONS

- Cellular
- GSM
- Balanced amplifiers
- Modulators

ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		800		1250	MHz
Insertion Loss, above 3.0 dB	800-1000		0.3	0.6	dB
	1000-1250		0.4	0.7	
Isolation	800-1000	15	17		dB
	1000-1250	13	16		
Phase Unbalance	800-1000		2.5	5.0	Degree
	1000-1250		2.5	5.0	
Amplitude Unbalance	800-1000		0.2	0.8	dB
	1000-1250		0.5	0.8	
VSWR	800-1000		1.2		(:1)
	1000-1250		1.2		

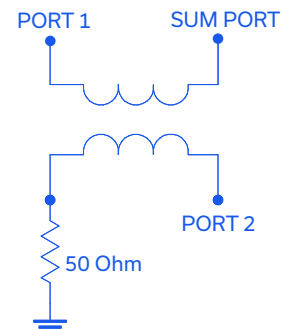
1. For applications requiring DC voltage to be applied to the RF ports. DC resistance to ground is 100 Mohms min.

MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
Power Input (as a splitter)	15W* max.

* Derate linearly to 7W at 100°C ambient. Permanent damage may occur if any of these limits are exceeded.

ELECTRICAL SCHEMATIC (NOTE 1)



Mini-Circuits

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ECO-010311
QCN-12AD+
ED-1164/2
AD/TD/CP/AM
211025
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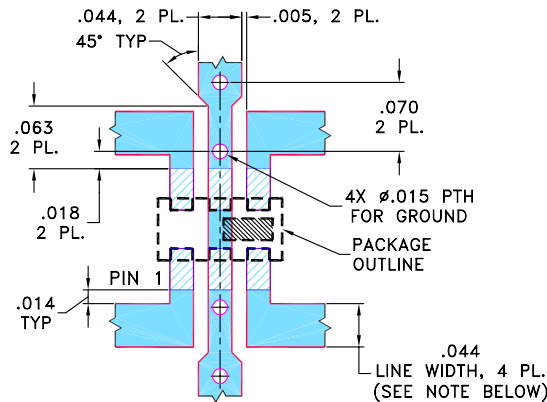


PIN CONNECTIONS

SUM PORT	1
PORT 1 (0°)	4
PORT 2 (+90°)	6
GROUND	2,5
50 OHM TERM EXTERNAL	3

PRODUCT MARKING: N/A

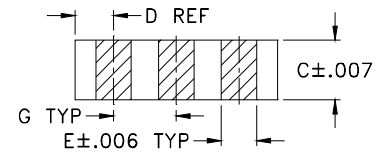
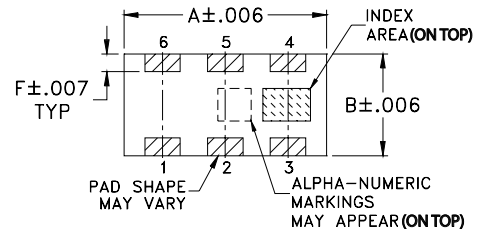
DEMO BOARD MCL P/N: TB-255
SUGGESTED PCB LAYOUT (PL-131)



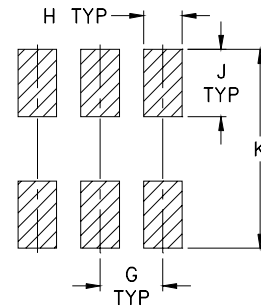
NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.020" ± 0.0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

OUTLINE DIMENSIONS (Inches/mm)

A	B	C	D	E	F
.126	.063	.035	.024	.022	.011
3.20	1.60	0.89	0.61	0.56	0.28
G	H	J	K	wt	
.039	.024	.042	.123	grams	
0.99	0.61	1.07	3.12	.020	

TAPE & REEL INFORMATION: F75